

**60V NPN MEDIUM POWER TRANSISTOR IN SOT223**

**Features**

- $BV_{CE0} > 60V$
- $I_C = 1A$  high Continuous Current
- Low saturation voltage  $V_{CE(sat)} < 500mV @ 1A$
- Complementary PNP Type: FZT591
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

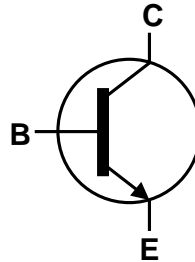
- Case: SOT223
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208
- Weight: 0.112 grams (approximate)

**Applications**

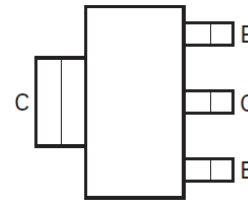
- Power MOSFET gate driving
- Low loss power switching



Top View



Device Symbol



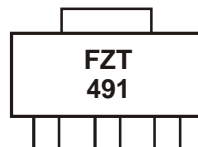
Top View  
Pin-Out

**Ordering Information** (Notes 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT491TA	FZT491	7	12	1,000

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com>

**Marking Information**



FZT491 = Product Type Marking Code

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	80	V
Collector-Emitter Voltage	V <sub>CEO</sub>	60	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	I <sub>C</sub>	1	A
Peak Pulse Current	I <sub>CM</sub>	2	A
Base Current	I <sub>B</sub>	200	mA

### Thermal Characteristics

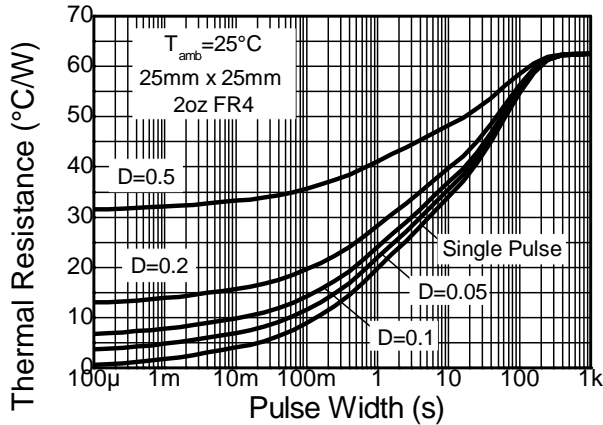
Characteristic	Symbol	Value	Unit	
Power Dissipation	P <sub>D</sub>	(Note 5)	2	W
		(Note 6)	3	W
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	(Note 5)	62.5	°C/W
		(Note 6)	41.7	°C/W
Thermal Resistance, Junction to Leads (Note 7)	R <sub>θJL</sub>	19.41	°C/W	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

### ESD Ratings (Note 8)

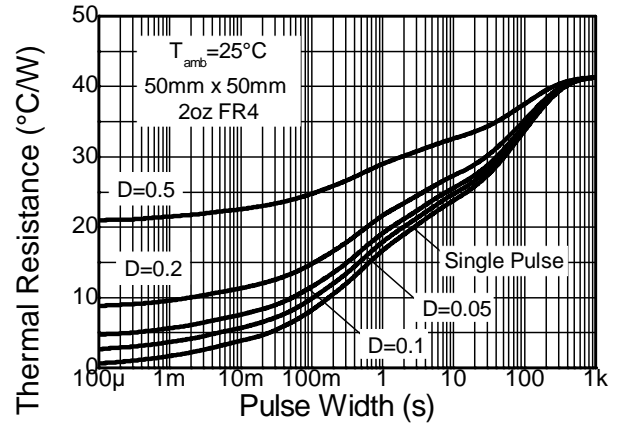
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	≥ 8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	C

- Notes:
5. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; device measured when operating in steady state condition.
  6. Same as note (5), except the device is mounted on 50mm X 50mm single sided 2oz weight copper.
  7. Thermal resistance from junction to solder-point (at the end of the collector lead).
  8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

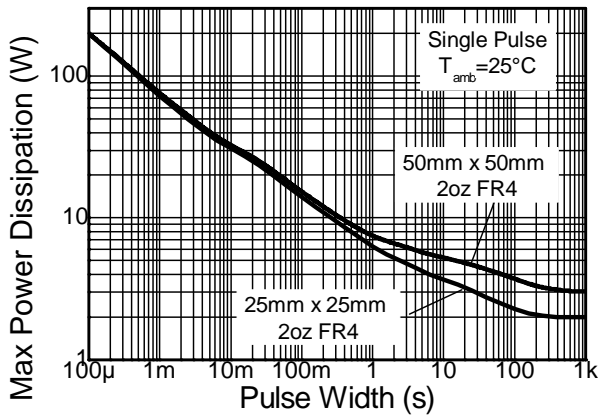
**Thermal Characteristics and Derating Information**



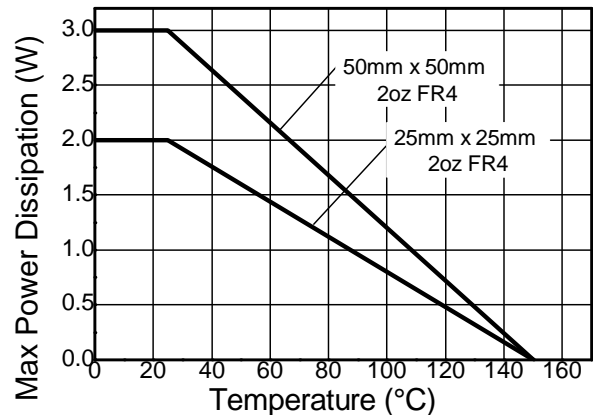
**Transient Thermal Impedance**



**Transient Thermal Impedance**



**Pulse Power Dissipation**



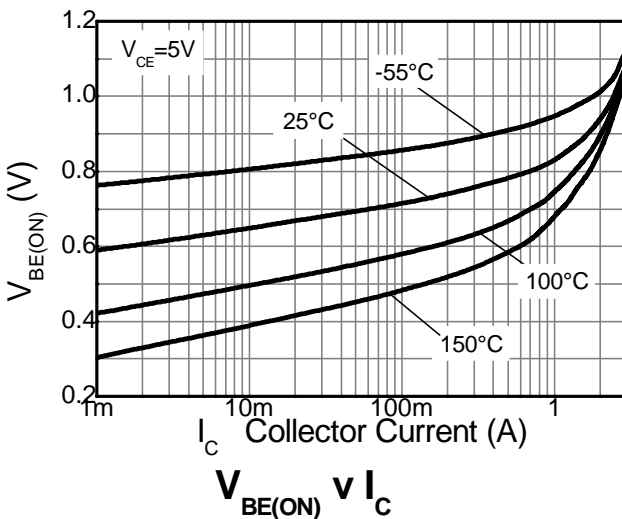
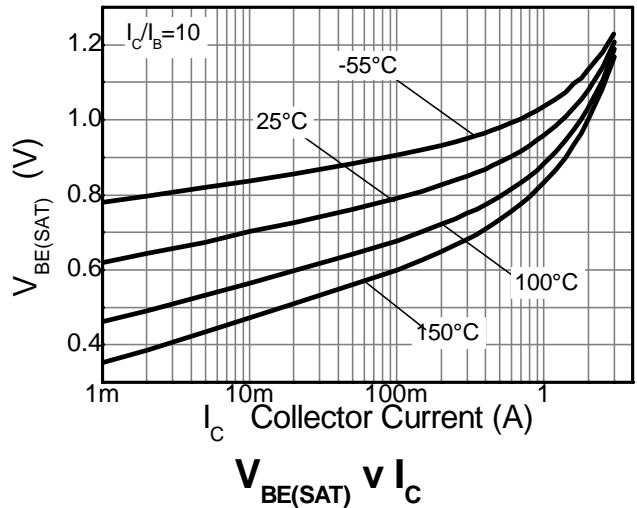
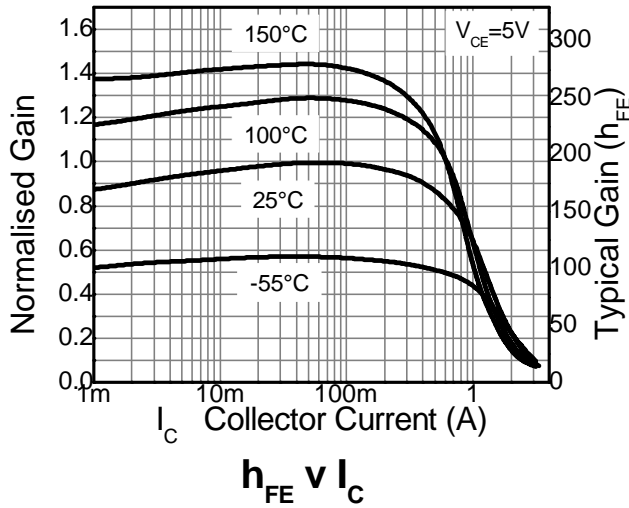
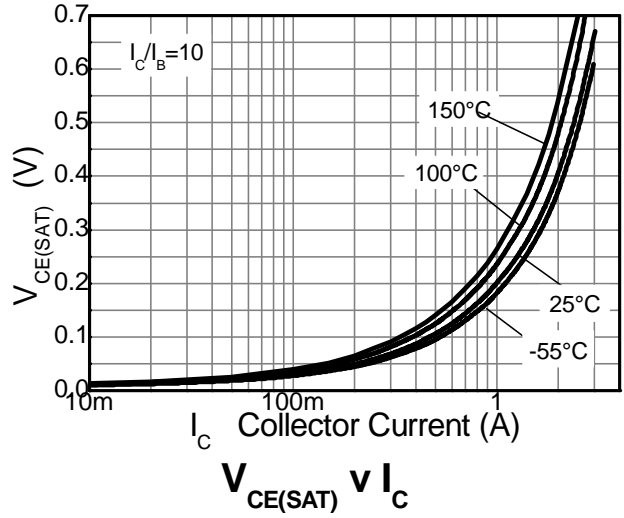
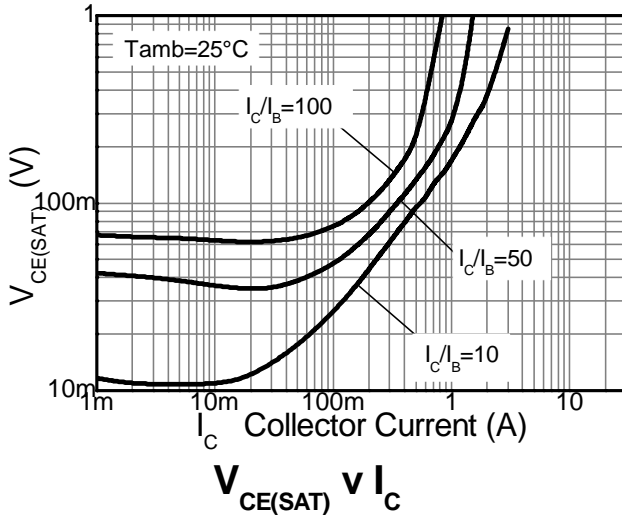
**Derating Curve**

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	80	–	–	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	60	–	–	V	I <sub>C</sub> = 10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.1	–	V	I <sub>E</sub> = 100μA
Collector Cut-off Current	I <sub>CBO</sub>	–	<1	100	nA	V <sub>CB</sub> = 60V
Collector Cut-off Current	I <sub>CES</sub>	–	<1	100	nA	V <sub>CES</sub> = 60V
Emitter Cut-off Current	I <sub>EBO</sub>	–	<1	100	nA	V <sub>EB</sub> = 5.6V
Collector-Emitter Saturation Voltage (Note 9)	V <sub>CE(sat)</sub>	–	100 160	250 500	mV	I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA I <sub>C</sub> = 1A, I <sub>B</sub> = 100mA
DC Current Gain (Note 9)	h <sub>FE</sub>	100 100 80 30	140 150 120 40	– 300 – –		I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V I <sub>C</sub> = 500mA, V <sub>CE</sub> = 5V I <sub>C</sub> = 1A, V <sub>CE</sub> = 5V I <sub>C</sub> = 2A, V <sub>CE</sub> = 5V
Base-Emitter Turn-On Voltage (Note 9)	V <sub>BE(on)</sub>	–	830	1000	mV	I <sub>C</sub> = 1A, V <sub>CE</sub> = 5V
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(sat)</sub>	–	965	1100	mV	I <sub>C</sub> = 1A, I <sub>B</sub> = 100mA
Output Capacitance	C <sub>obo</sub>	–	–	10	pF	V <sub>CB</sub> = 10V, f = 1MHz
Current Gain-Bandwidth Product	f <sub>T</sub>	150	–	–	MHz	V <sub>CE</sub> = 10V, I <sub>C</sub> = 50mA f = 100MHz

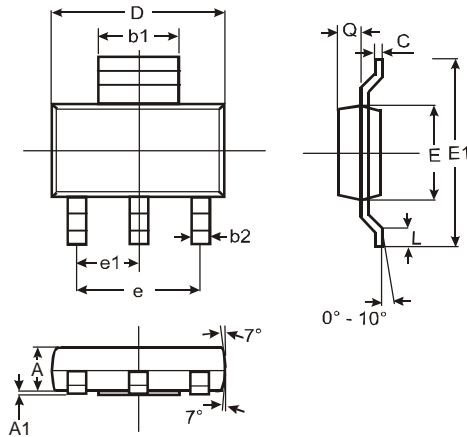
Notes: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%

**Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



## Package Outline Dimensions

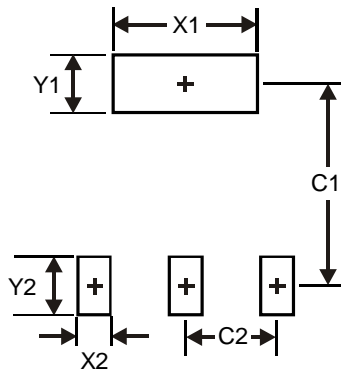
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b1	2.90	3.10	3.00
b2	0.60	0.80	0.70
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	—	—	4.60
e1	—	—	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3

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